



CONTINUATION PATENT APPLICATION TRANSMITTAL

(filed under 37 C.F.R. §1.53(b))

Attorney Docket No.: BDG024-1

Inventor: Chuen Rong Leu of Hsinchu, Taiwan
Charles W.C. Lin of Singapore

Title: METHOD OF MAKING A SEMICONDUCTOR CHIP ASSEMBLY
WITH AN EMBEDDED METAL PILLAR

Prior Group Art Unit: Unknown

Prior Examiner: Unknown

**Mail Stop Patent Application
Commissioner for Patents**

P.O. Box 1450
Alexandria, VA 22313-1450

This patent application is a CONTINUATION application of pending prior U.S. Application Serial No. 10/714,794 filed November 17, 2003, which is a continuation-in-part application of U.S. Application Serial No. 10/235,331 filed September 5, 2002, which is a divisional application of U.S. Application Serial No. 09/939,140 filed August 24, 2001, which is a continuation-in-part application U.S. Application Serial No. 09/878,626, filed June 11, 2001, which is a continuation-in-part application of U.S. Application Serial No. 09/687,619, filed October 13, 2000.

The '794 application also claims the benefit of U.S. Provisional Application Serial No. 60/509,299 filed October 7, 2003, and U.S. Provisional Application Serial No. 60/507,145 filed September 30, 2003.

Enclosed for filing with the above-identified utility patent application, please find the following:

1. Copy of the '794 application as originally filed, consisting of
 - Specification (66 pages)
 - Claims (17 pages)
 - Abstract (1 page)
 - Drawings (36 sheets) (informal)
2. Copy of Declaration from the '794 application
3. Preliminary Amendment
4. Request for Nonpublication of Application
5. Information Disclosure Statement (IDS/PTO-1449)
6. Return Postcard (MPEP 503) (*specifically itemized*)



FEE CALCULATION:

	(COL. 1) NO. FILED			(COL. 2) NO. EXTRA	SMALL ENTITY	
					RATE	FEE
BASIC FEE:						\$385
TOTAL CLAIMS:	200	-	20	180	X \$9 =	\$1620
INDEP. CLAIMS:	11	-	3	8	X \$43 =	\$344
MULTIPLE DEPENDENT CLAIMS: 0					+\$140 =	\$0
TOTAL FILING FEE						\$2349

OTHER INFORMATION:

1. This application is entitled to small entity status. A Statement Claiming Small Entity Status by Small Business Concern was filed in the '794 application. Small entity status is still proper and desired.
2. Charge the \$2349 to Deposit Account No. 502178/BDG024-1 and charge any underpayment or credit any overpayment to this Account.
3. The Power of Attorney to David M. Sigmond appears in the '794 application.
4. This application and the '794 application are owned by Bridge Semiconductor Corporation.
5. Correspondence Address:

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EXPRESS MAIL MAILING LABEL NUMBER: EU267708542US
DATE OF DEPOSIT: NOVEMBER 21, 2003

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Respectfully submitted,



David M. Sigmond
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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Chuen Rong Leu et al.
Assignee: Bridge Semiconductor Corporation
Title: METHOD OF MAKING A SEMICONDUCTOR CHIP
ASSEMBLY WITH AN EMBEDDED METAL PILLAR
Serial No.: Unknown Filed: Herewith
Examiner: Unknown Group Art Unit: Unknown
Atty. Docket No.: BDG024-1

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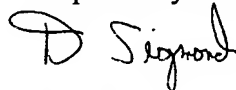
REQUEST FOR NONPUBLICATION OF APPLICATION

Applicant requests that the above-identified application not be published under 35 U.S.C. § 122(b).

Applicant certifies that the invention disclosed in this application has not been and will not be the subject of an application filed in another country, or under a multilateral international agreement, that requires publication at eighteen months after filing.

This request is being submitted with this application on filing.

Respectfully submitted,



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